

Fuseholder Open Design, Holder for OMF 63, OMF 125 and OMT 125, SMD



125 VAC · 5 A (UL/CSA)

**Description**

- Suitable for SMD fuse-links OMF 63/OMF 125/OMT 125


Standards

- UL 512 and CSA C22.2 no. 39

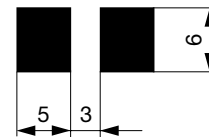
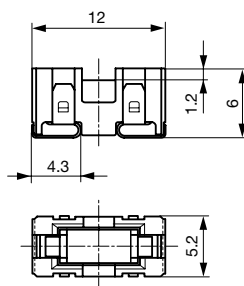
Approvals

- UL File Number: E39328

References[General Product Information](#)[Packaging Details](#)Fuseholder to [OMF 125](#); [OMF 63](#); [OMT 125](#)**Weblinks**[Approvals](#), [RoHS](#), [CHINA-RoHS](#), [e-Store](#), [Distributor-Stock-Check](#), [Accessories](#), [Product Change Notification \(PCN\)](#)**Technical Data**

Fuse-Link	OMx 63/125 Fuse
Mounting	PCB
Terminal	Solder SMT
Rated Voltage	125 VAC
Rated Current	5 A (UL/CSA)
Degree of Protection	IP 00
Admissible Ambient Air Temp.	-40 °C to 85 °C
Climatic Category	40/085/21 acc. to IEC 60068-1
Material: Socket	Thermoplastic, Beige, UL 94V-0
Material: Terminals	Tin-Plated Copper Alloy
Unit Weight (Socket/Cap)	3.9 g
Storage Conditions	0 °C to 60 °C, max. 70% r.h.
Product Marking	 , Approvals

Soldering Methods	Reflow
Solderability	245 °C / 3 sec acc. to IEC 60068-2-20, Test Td
Resistance to Soldering Heat	260 °C / 10sec acc. to IEC 60068-2-20, Test Td
Dielectric Strength	> 3kV between L-N (50Hz; 1 min)
Impulse Withstand Voltage	> 4kV between L-N
Insulation Resistance	> 10 MΩ between L-N (500 VDC; 1 min)
Overvoltage Category	I - III acc. to IEC 60664-1
Pollution Degree	1 - 3 acc. to IEC 60664-1

Abmessungen
 12 mm


Soldering pads

Packaging Unit

- .xx = .11 Plastic Bag (100 pcs.)
- .xx = .22 Blister Tape 33 cm Reel (750 pcs.)
- .xx = .23 Blister Tape 33 cm Reel (1500 pcs.)